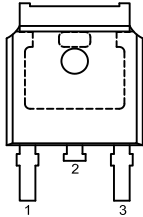



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	not connected	 DPAK (SOT428)	
2	K	cathode[1]		
3	A	anode		
mb	K	mounting base; cathode		

[1] It is not possible to connect to pin 2 of the TO252 package.

6. Ordering information

Table 3. Ordering information

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BYV25FD-600	TO252	BYV25FD-600,118	Reel	2500	TO252N	14-Nov-2016

7. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	600	V
V _{RWM}	crest working reverse voltage		-	600	V
V _R	reverse voltage	DC	-	600	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 121 °C; SQW; Fig. 1; Fig. 2	-	5	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 121 °C; SQW	-	10	A
I _{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; SIN; Fig. 3	-	60	A
		t _p = 8.3 ms; T _{j(init)} = 25 °C; SIN	-	66	A
T _{stg}	storage temperature		-40	150	°C
T _j	junction temperature		-	150	°C

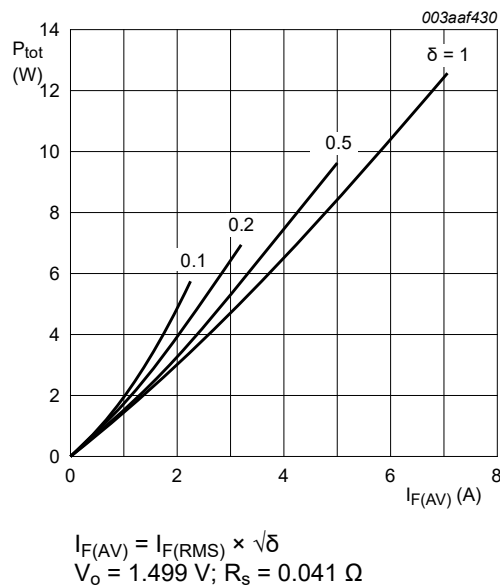


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

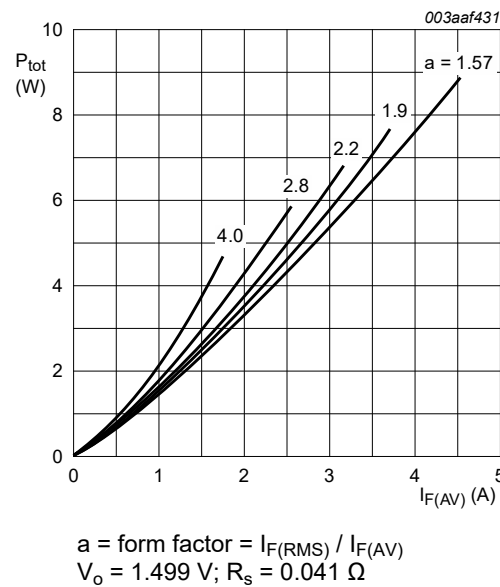
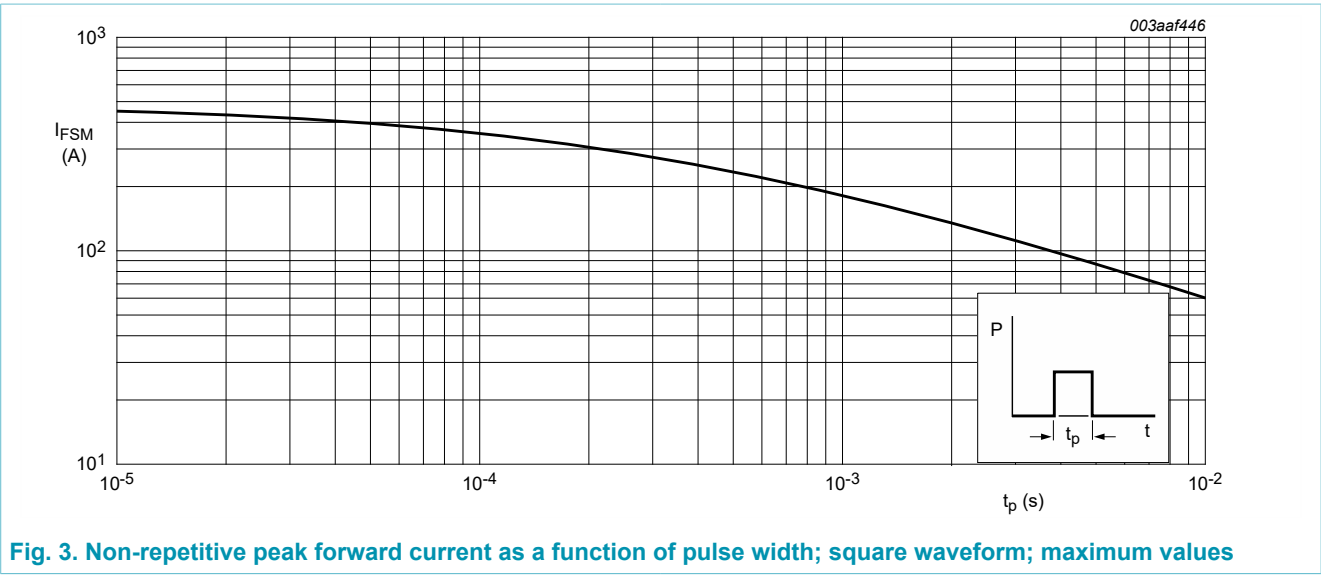


Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values



8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig. 4		-	-	3	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air	[1]	-	50	-	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

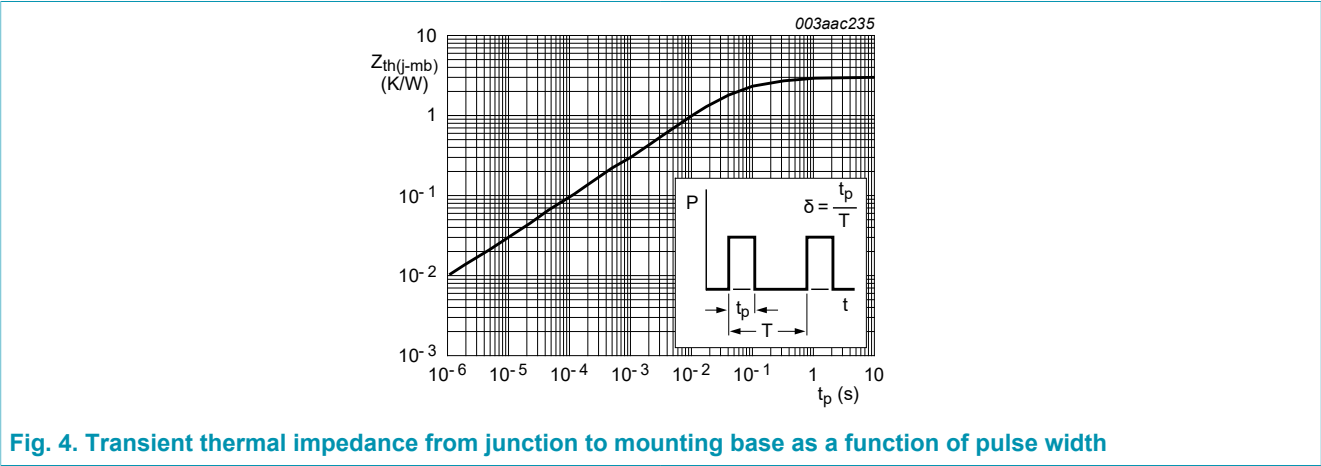
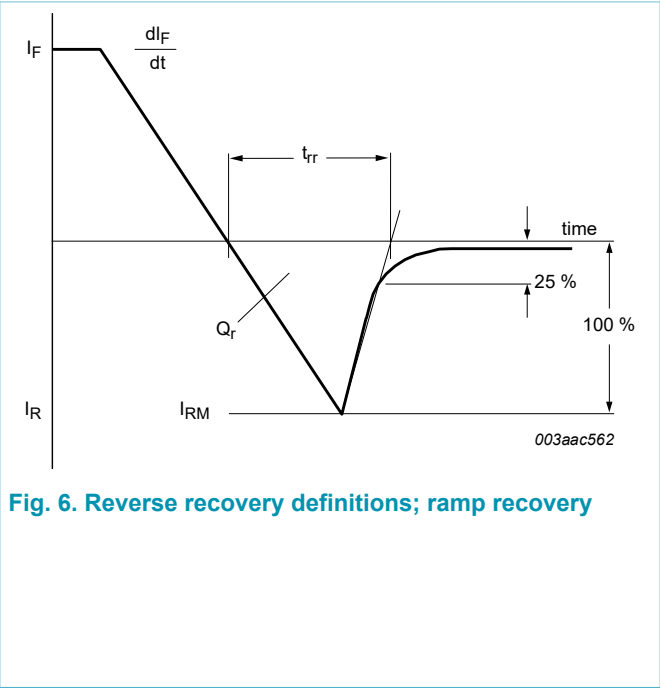
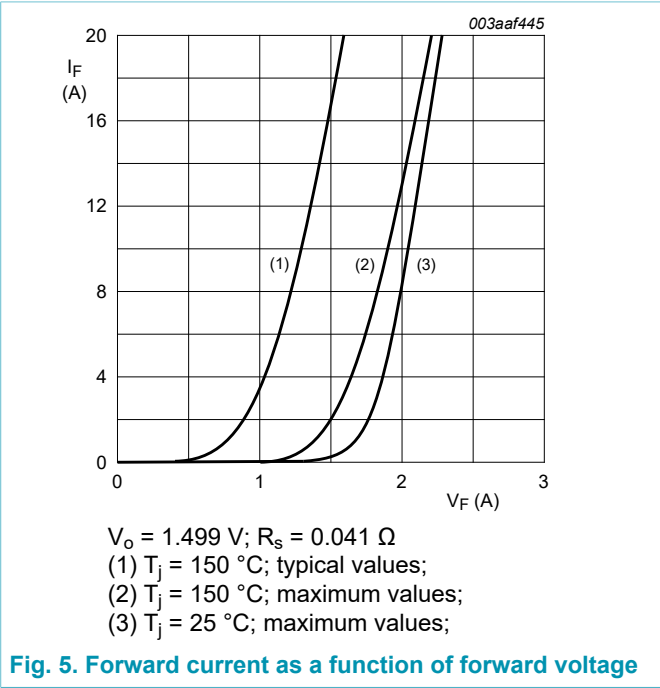


Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse width

9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
V _F	forward voltage	I _F = 5 A; T _J = 25 °C; Fig. 5		-	1.3	1.9	V
		I _F = 5 A; T _J = 150 °C; Fig. 5		-	1.1	1.7	V
I _R	reverse current	V _R = 600 V; T _J = 100 °C		-	-	1.5	mA
		V _R = 600 V; T _J = 25 °C		-	-	50	μA
Dynamic characteristics							
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _J = 25 °C; Fig. 6		-	17.5	35	ns
I _{RM}	peak reverse recovery current			-	1.5	-	A
Q _r	recovered charge			-	13	-	nC
V _{FR}	forward recovery voltage	I _F = 1 A; dI _F /dt = 100 A/μs; T _J = 25 °C; Fig. 7		-	3.2	-	V



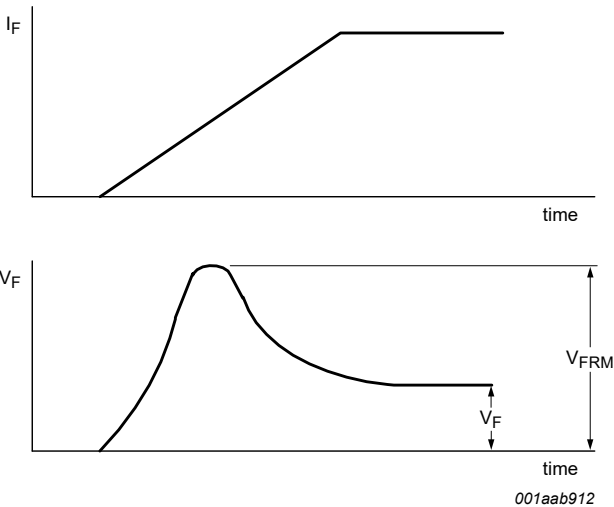
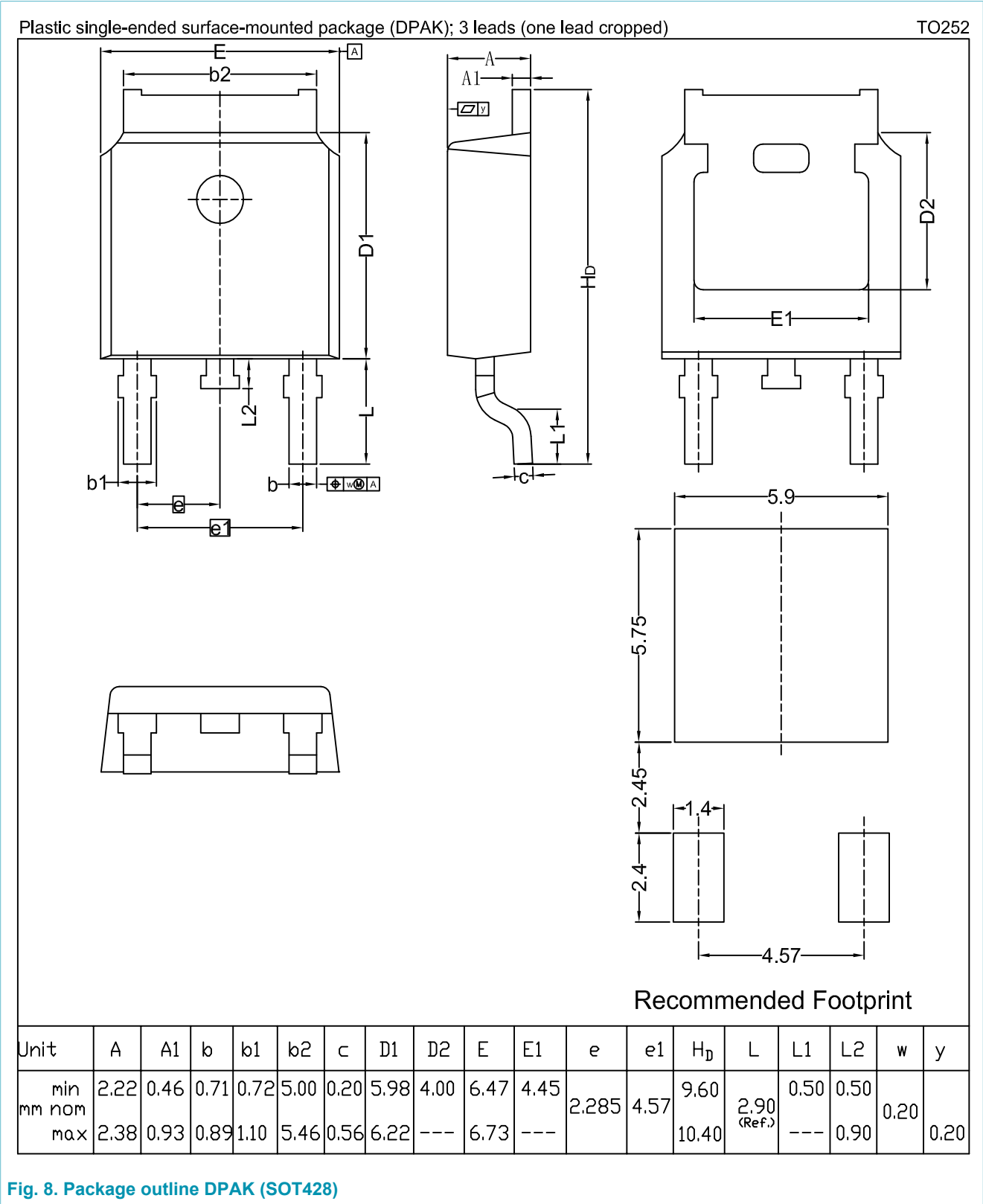


Fig. 7. Forward recovery definitions

10. Package outline



11. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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